

Transmission Line Structure Table Impedance Id Transmission Line Target Impedance Calculated Impedance Trace layer | Wide Trace Width | Narrow Trace Width | Gap Reference layers Substack Clearance Target Tolerance Edge-Coupled Coated Microstrip 90 88.55 Top Layer 0.17mm 0.17mm 0.10mm Int1 (GND) Board Layer Stack 0.13mm 10% Edge-Coupled Coated Microstrip 100 98.05 0.12mm 0.12mm 0.10mm Int1 (GND) Board Layer Stack 0.13mm 10% Top Layer 10% Coated Microstrip 50 49.93 0.35mm 0.35mm Int1 (GND) Board Layer Stack 0.13mm Top Layer 50 Board Layer Stack 0.13mm 49.52 10% Offset Stripline Int1 (GND) 0.28mm 0.28mm Top Layer,Int2 (PWR) 50 Offset Stripline 49.52 Int2 (PWR) 0.28mm 0.28mm Int1 (GND),Bottom Layer Board Layer Stack 0.13mm 10% Edge-Coupled Coated Microstrip 90 88.55 Bottom Layer 0.17mm 0.17mm 0.10mm Int2 (PWR) Board Layer Stack 0.13mm 10% 10% Edge-Coupled Coated Microstrip 100 98.05 Bottom Layer 0.12mm 0.12mm 0.10mm Int2 (PWR) Board Layer Stack 0.13mm

0.35mm

Bottom Layer 0.35mm

_ay		Material ——	Layer Top Overlay	Thickness	Dielectric Material	Type Legend	Gerbe GTO
		Surface Material PbSn	Top Solder Top Surface Finish	0.03mm 0.02mm	SM-001	Solder Mask Surface Finish	GTS
		CF-004	Top Layer	0.04mm		Signal	GTL
		Prepreg		0.21mm	PP-017	Dielectric	
772		CF-004	Int1 (GND)	0.02mm		Signal	G1
		Core		1.06mm	Core-039	Dielectric	
///	7.11.11.11.11.11.11.11	—— CF-004	Int2 (PWR)	0.02mm		Signal	G2
		Prepreg		0.21mm	PP-017	Dielectric	
		CF-004	Bottom Layer	0.04mm		Signal	GBL
		PbSn	Bottom Surface Finish	0.02mm		Surface Finish	
		Surface Material	Bottom Solder	0.03mm	SM-001	Solder Mask	GBS
			Bottom Overlay			Legend	GBO

49.93

50

Coated Microstrip

Symbol	Count	Hole Size	Plated	Hole Tolerance
∇	28	0.15mm	Plated	
	2	0.20mm	Plated	
0	88	0.30mm	Plated	
\Diamond	2	0.95mm	Plated	
∇	10	0.97mm	Plated	
*	4	1.10mm	Plated	
X	2	1.25mm	Non-Plated	
0	1	1.57mm	Plated	
×	2	1.65mm	Plated	
	4	1.70mm	Plated	
¢	2	3.25mm	Non-Plated	
	145 Total			

Int2 (PWR)

Drill Table

Board Layer Stack 0.13mm

10%